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JUL 25 2005

Application No.: 10/728,150

Docket No.: JCLA8534-D

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In Re Application of:

Jin-Yuan Lee et al.

Serial No.: 10/728,150

Filed: 12/03/2003

For: INTEGRATED CHIP PACKAGE
STRUCTURE USING ORGANIC
SUBSTRATE AND METHOD OF
MANUFACTURING THE SAME

Examiner: THAI, LUAN C

Art Unit: 2891

Docket No.: JCLA8534-D

No fee is believed to be due. However, the Commissioner is authorized to charge any fees required in connection with the filing of this paper to account No. 50-0710 (Order No.: JCLA8534-D)

AMENDMENT AND RESPONSE TO OFFICE ACTION

Mail Stop Amendment AF
Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Dear Sir,

The Office Action mailed April 25, 2005 has been carefully considered. In response thereto, please enter the following amendments and consider the following remarks.

07/26/2005 HLE333 00000045 500710 10728150
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